

C1206C332MDRACTU

Aliases (C1206C332MDRAC7800)

SMD Comm X7R HV, Ceramic, 3300 pF, 20%, 1000 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1206



Click here for the 3D model.

Dimensions		
Chip Size	1206	
L	3.2mm +/-0.2mm	
W	1.6mm +/-0.2mm	
Т	1mm +/-0.10mm	
В	0.5mm +/-0.25mm	

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500
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General Information			
Series	SMD Comm X7R HV		
Style	SMD Chip		
Description	SMD, MLCC, High Voltage, Temperature Stable		
Features	High Voltage		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Component Weight	25 mg		
Shelf Life	78 Weeks		
MSL	1		

Specifications				
Capacitance	3300 pF			
Measurement Condition	1 kHz 1.0Vrms			
Capacitance Tolerance	20%			
Voltage DC	1000 VDC			
Dielectric Withstanding Voltage	1200 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	X7R			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms			
Dissipation Factor	2.5% 1 kHz 1.0Vrms			
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours			
Insulation Resistance	100 GOhms			

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